







DISCRIPTION

FEATURES

Very Small Foot Print Flat-top for Pick & Place Increased Size Selection Guide

OPTIONS

Tape & Reel is Standard
Bulk Packing Available for smaller quantites
Tolerance: M=20% is Standard

APPLICATIONS

Ideal for Palm-Top and Laptop DC to Dc converter PDA's flash memory Step-up, step-down Converters

PHYSICAL CHARACTERISTICS

• measuring Frequency (L): 1 KHz, 0.1 Vrms, HP4284A

Operating Temperature : -40°C ~ +85°C
 Storage Temperature : -40°C ~ +105°C

Soldering Methods: Vapor Phase, Infrared Reflow
 Resistance to soldering heat: 260°C for 10 seconds
 Solvent resistance: Conforms to MIL-STD-202E

ELECTRICAL SPECIFICATIONS

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	33	μH	see Site 2
Q factor		Q			min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	0,12	Ω	max.
Self-Res. Freq.		SRF		MHz	min.
Test-Freq.			0,001	MHz	
Rated Current		IDC	2,30	Α	max.
Saturation Current		Isat		Α	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation **SMT POWER** of this component into any equipment with higher and more reliable requirements such as aviation, **INDUCTOR** aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No .: S21005-330 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 16.06.2009 APPD: **FINISH** Vienna 1 from 2 Pong Sheet



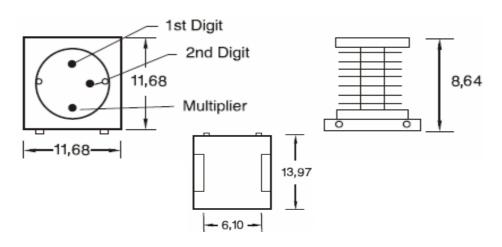






TECHNICAL INFORMATIONS

Dimensions (mm)

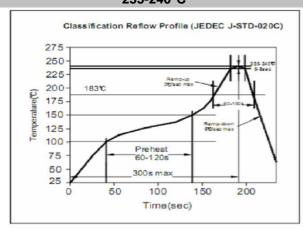


Ordering Information

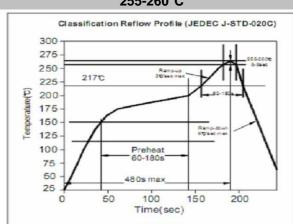
Serie and Range				
S21005-330				

Tolerance	ROHS	Packing	
M	R	TR	
M = 20%	R = ROHS	BU = Bulk Ware	
	N = non ROHS	TR = Tape Reel	

Soldering Profile for Lead Free Soldering 235-240°C



Soldering Profile for Lead Free Soldering 255-260°C



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SMT POWER INDUCTOR

Part No.: **\$21005-330**

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